

PC55H10 V0

Product Specification

Approval Sheet

PC55H10 V0
Product Specification

RoHS

Product	White SMD LED
Part Number	PC55H10 V0
Issue Date	2015/11/25



■ Feature

- ✓ White SMD LED (L x W x H) of 5.8 x 5.2 x 0.7 mm
- ✓ ANSI binning
- ✓ Dice Technology : InGaN
- ✓ Qualified according to JEDEC moisture sensitivity Level 3
- ✓ Environmental friendly ; RoHS compliance
- ✓ Packing : 500 pcs/reel

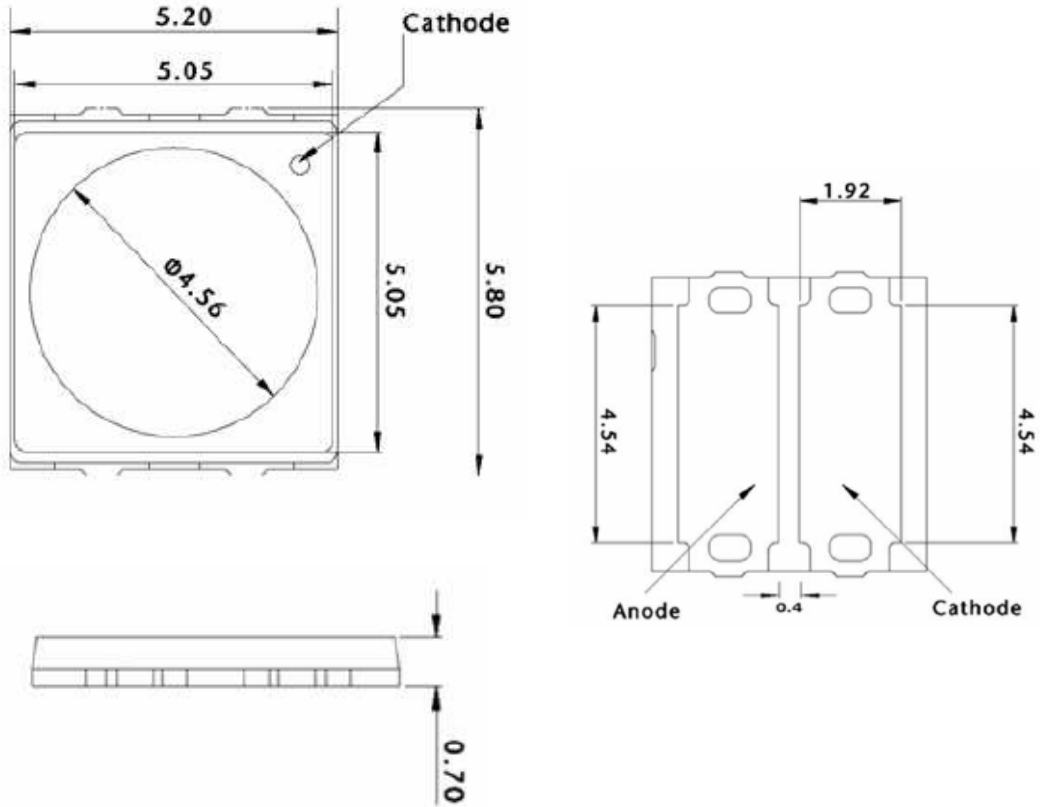
■ Applications

- ✓ MR16, GU10
- ✓ General lighting
- ✓ Outdoor lighting

Outline Dimension

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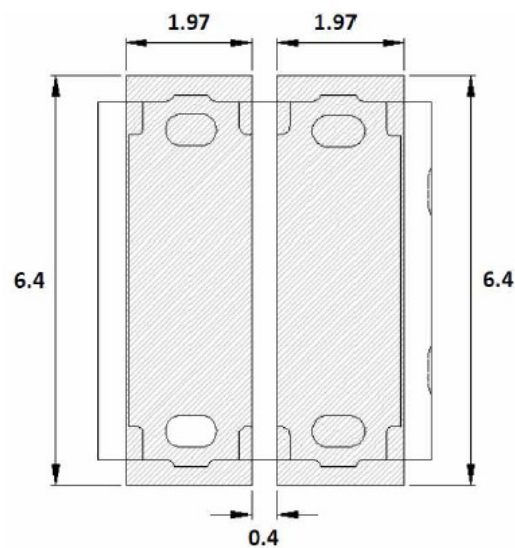
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Unit: mm,

Tolerance: ± 0.1 mm

■ Recommended Soldering Pad



Performance

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■ Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage ⁽¹⁾	V _F	I _F = 150 mA	32.6	36.2	39.8	V
Color Rendering Index ⁽²⁾	R _a		80	-	-	-
Color Rendering Index ⁽³⁾	R ₉		0			
View Angle	θ		-	120	-	deg
Thermal Resistance ⁽⁴⁾	R _{th}		-	4	-	°C/W

(1) The Forward Voltage tolerance is ±0.1V

(2) The Color Rendering Index is measured at Ta=85°C and tolerance is ±2

(3) The R₉ is measured at Ta=85°C and tolerance is ±6.

(4) Thermal resistance is calculated from junction to solder

■ Luminous Flux (Ta=25°C)

CCT	Condition	Rank	Typ.	Unit
2600K~4000K	I _F = 150 mA	GP,GQ,GR	660	lm
5000K~7000K		GQ,GR,GS	710	

* The luminous flux tolerance is ± 7%

■ Absolute Maximum Ratings

Parameter	Symbol	value	Unit
DC Forward Current ⁽¹⁾	I _F	240	mA
Power Dissipation	P _D	8.7	W
Pulse Forward Current ⁽²⁾	I _{FP}	360	mA
Storage Temperature	T _{stg}	-40 ~ 100	°C
Operating Temperature	T _{opr}	-40 ~ 100	°C
Junction Temperature	T _J	125	°C
Assembly Temperature	-	260 (max. 10sec)	°C

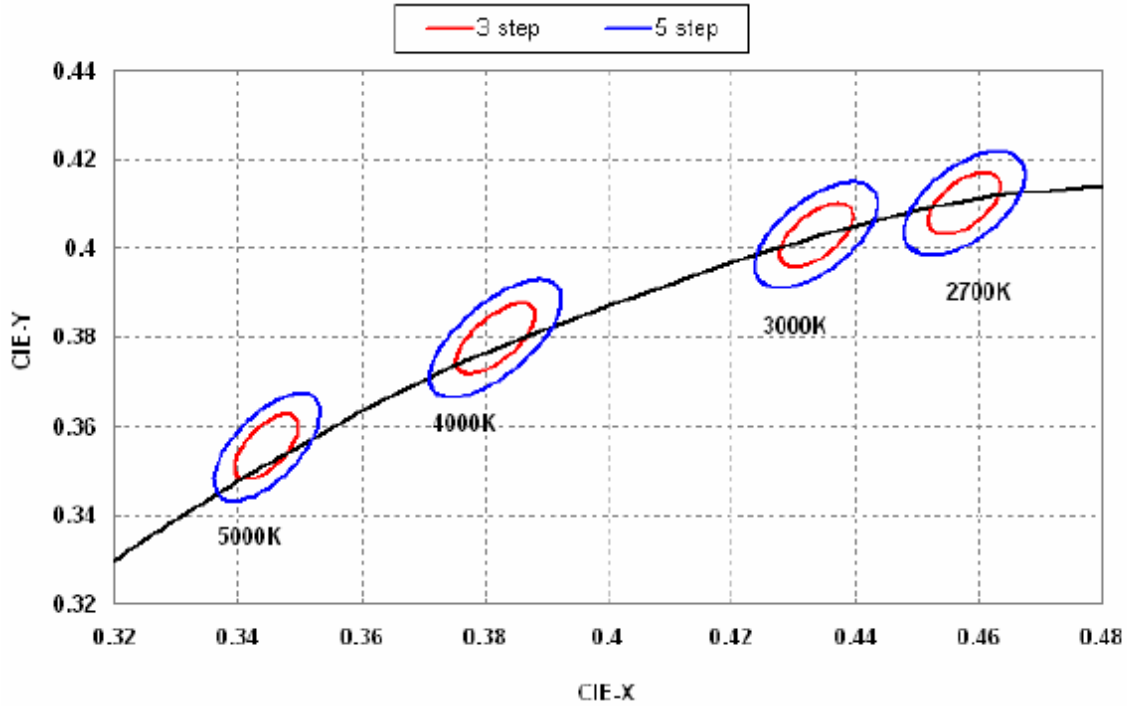
(1) Proper current rating must be observed to maintain junction temperature below maximum at all time

(2) IFP Condition: Duty 1/10, Pulse within 10msec

Binning

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Chromaticity Coordinates(Ta=85°C)



Items	2700K 3-Step (273S)	3000K 3-Step (303S)	4000K 3-Step (403S)	5000K 3-Step (503S)
Center Point, Cx	0.4578	0.4338	0.3818	0.3447
Center Point, Cy	0.4101	0.4030	0.3797	0.3553
Major Axis, a	0.0081	0.0083	0.0093	0.0082
Minor Axis, b	0.0042	0.0040	0.0040	0.0035
Rotation Angle	53.7	53.2	53.7	59.6

Items	2700K 5-Step (275S)	3000K 5-Step (305S)	4000K 5-Step (405S)	5000K 5-Step (505S)
Center Point, Cx	0.4578	0.4338	0.3818	0.3447
Center Point, Cy	0.4101	0.4030	0.3797	0.3553
Major Axis, a	0.0135	0.01390	0.0156	0.0137
Minor Axis, b	0.0070	0.00680	0.0040	0.0059
Rotation Angle	53.7	53.2	53.7	59.6

■ **Bin code definition**

CIE Rank	Luminous Flux Rank	V _F Rank
273S	GP	Y

V _F Rank	Condition	Min.	Max.
Y	I _F = 150 mA	32.6	39.8

Luminous Flux Rank	Condition	Min.	Max.
GP	I _F = 150 mA	550	600
GQ		600	660
GR		660	726
GS		726	799

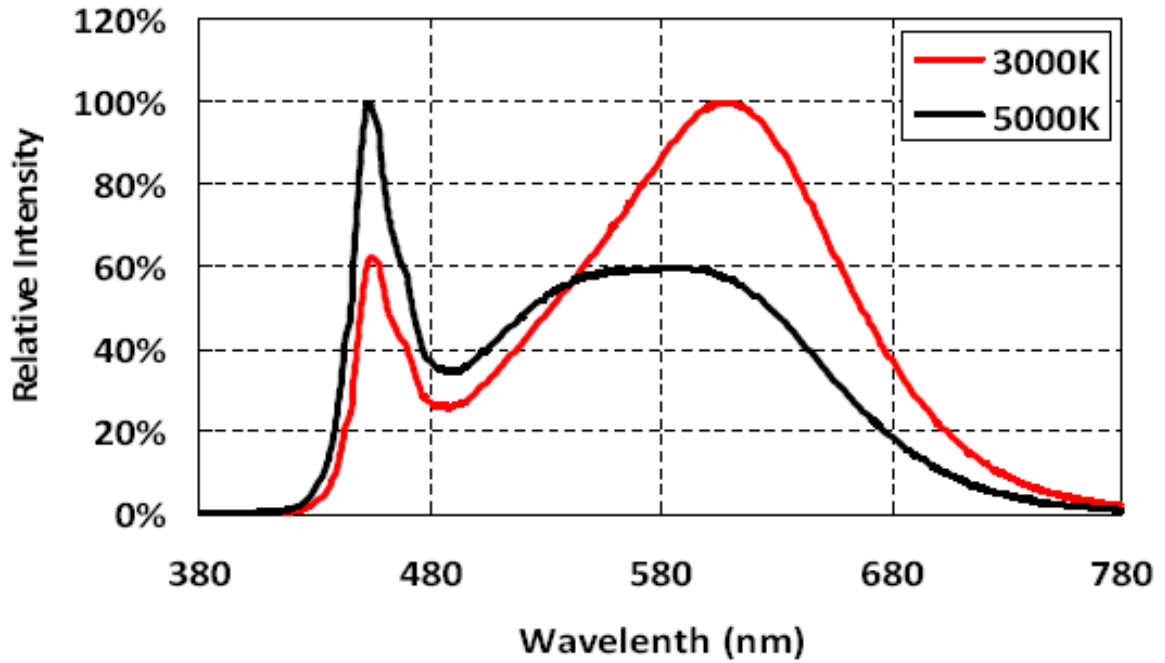
Note:

- (1) Correlated color Temperature is derived from the CIE 1931 Chromaticity diagram
- (2) CIE Measurement tolerance is ± 0.005
- (3) The luminous flux tolerance is ±7%
- (4) The Forward Voltage tolerance is ±3%

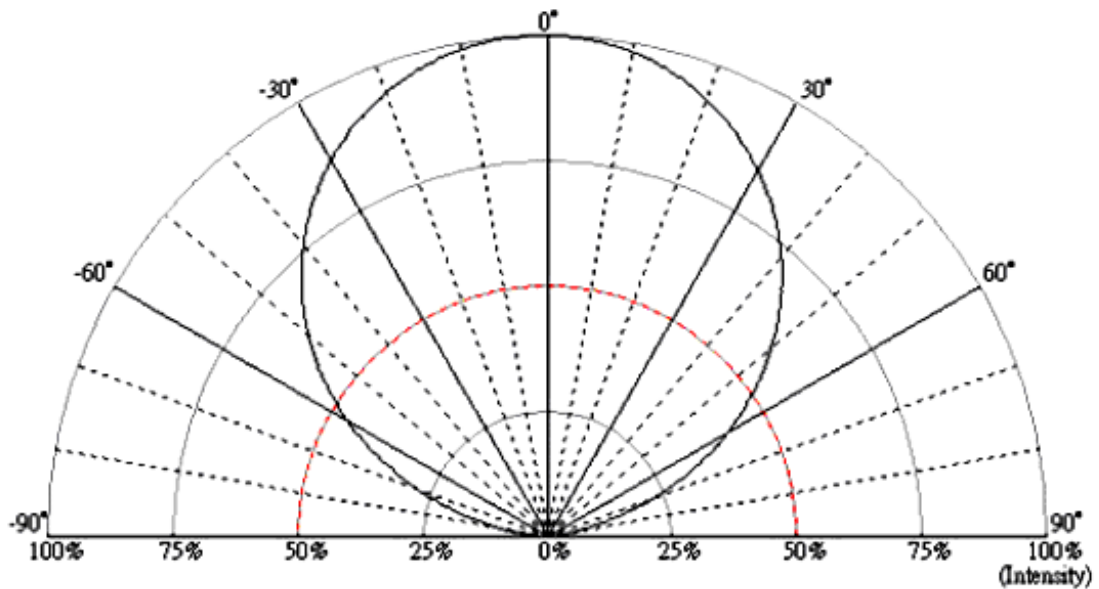
Characteristics

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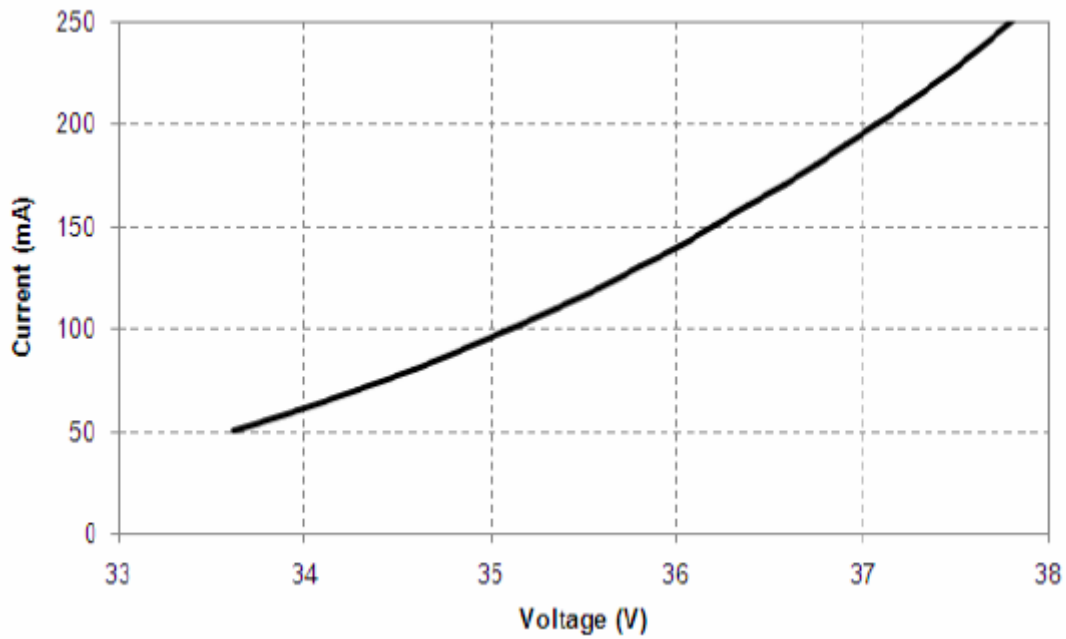
Radiation Pattern



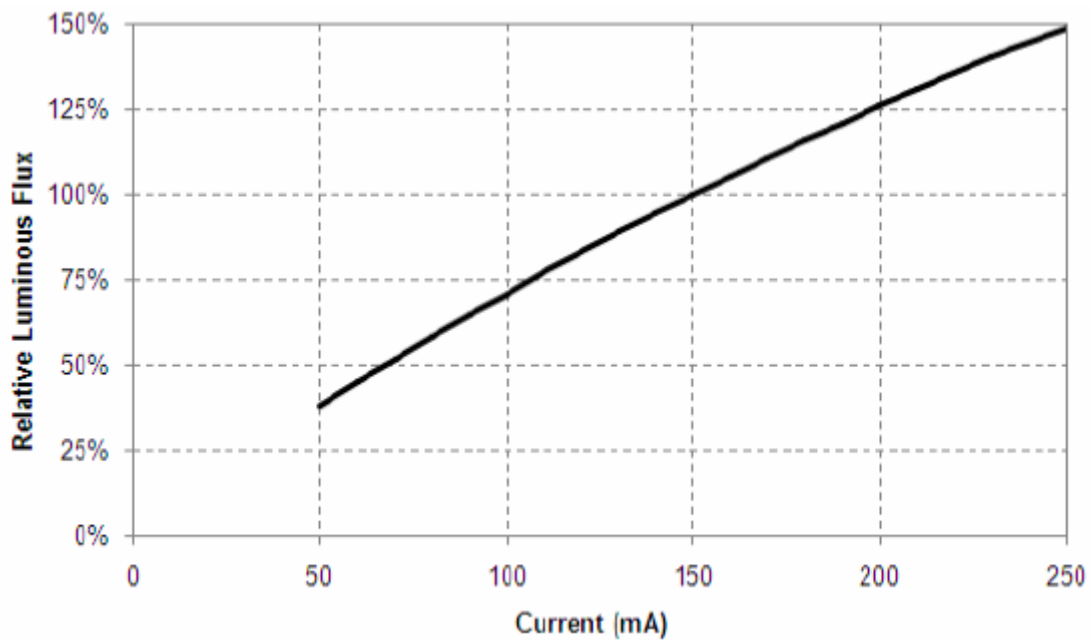
Radiation Pattern



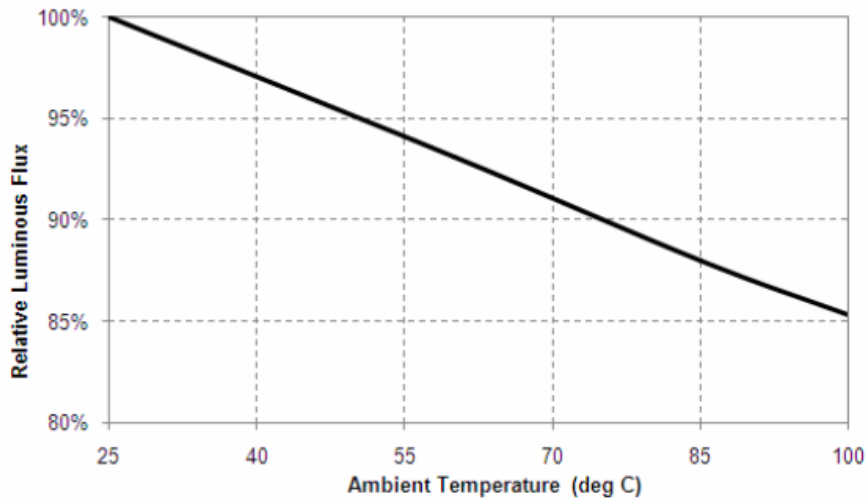
■ Forward Voltage vs. Forward Current



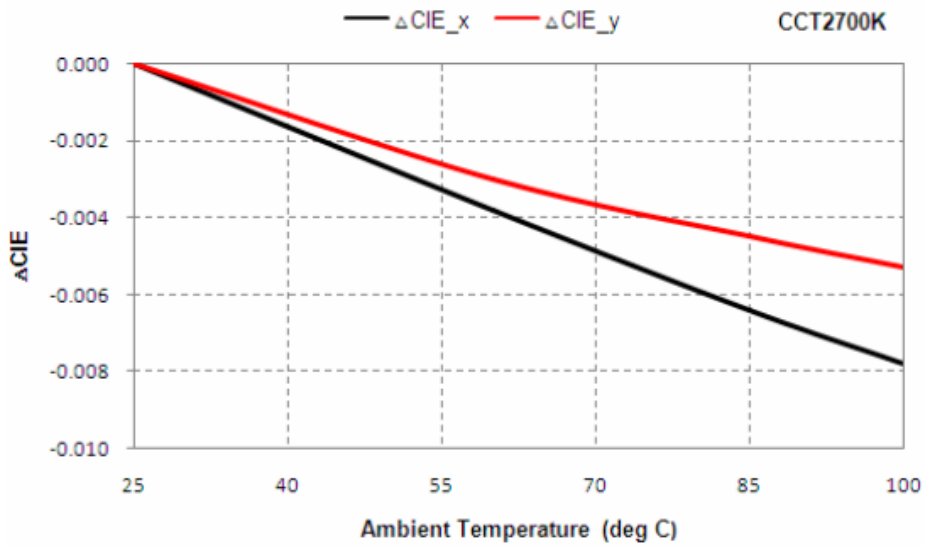
■ Forward Current vs. Relative Luminosity



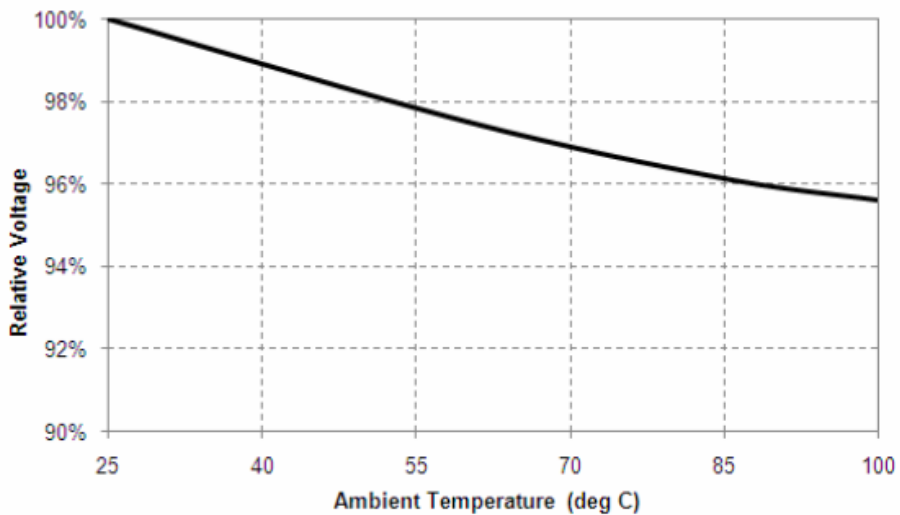
■ Relative Luminous Intensity vs. Ambient Temperature



■ Chromaticity vs. Ambient Temperature



■ Relative VF vs. Ambient Temperature



Reliability

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Reliability test

Item	Condition	Time/Cycle
Steady State Operating Life of Low Temperature -40°C	-40°C Operating	1000 Hrs
Steady State Operating Life of High Temperature 60°C	60°C Operating	1000 Hrs
Steady State Operating Life of High Temperature 85°C	85°C Operating	1000 Hrs
Steady State Operating Life of High Temperature 100°C	105°C Operating	1000 Hrs
Low temperature storage -40°C	-40°C Storage	1000 Hrs
High temperature storage 100°C	105°C Storage	1000 Hrs
Steady State Operating Life of High Humidity Heat 60°C 90%	60°C/90% Operating	1000 Hrs
Resistance to soldering heat on PCB (JEDEC MSL3)	pre-store@60°C, 60%RH for 52hrs Tsltd max.=260°C 10sec	3 Times
Thermal shock	-40°C/20minr ~5minr ~ 100°C/20min	300 Cycles

Judgment Criteria

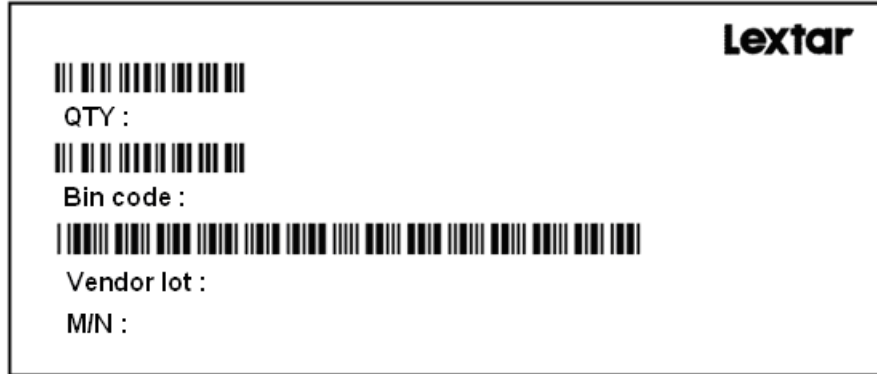
Item	Symbol	Test Condition	Judgment Criteria
Forward Voltage	Vf	150mA	$\Delta V_f < 10\%$
Luminous Flux	Iv	150mA	$\Delta I_v < 30\%$

Packing

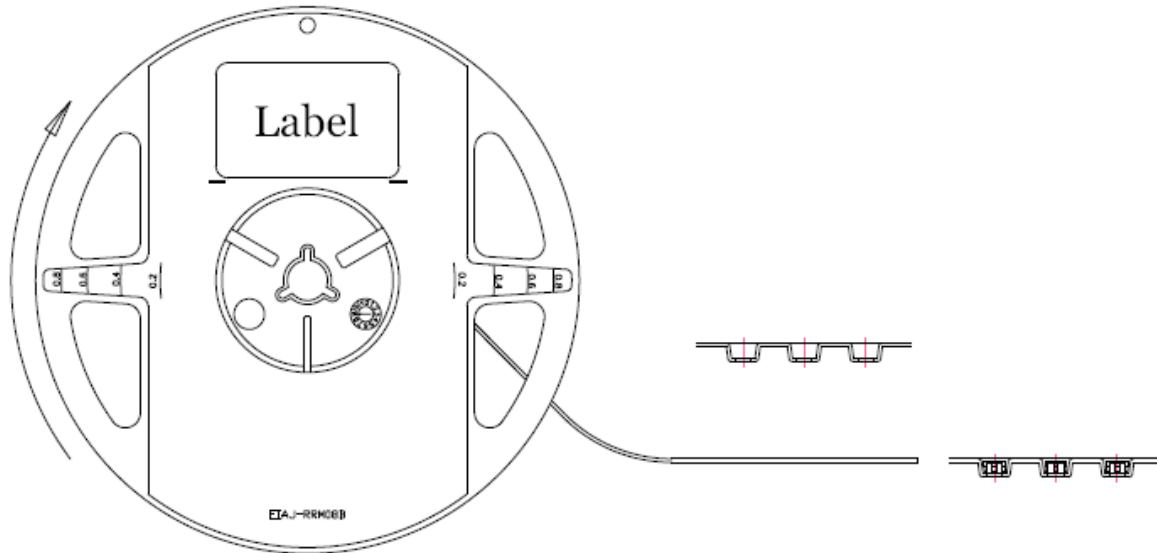
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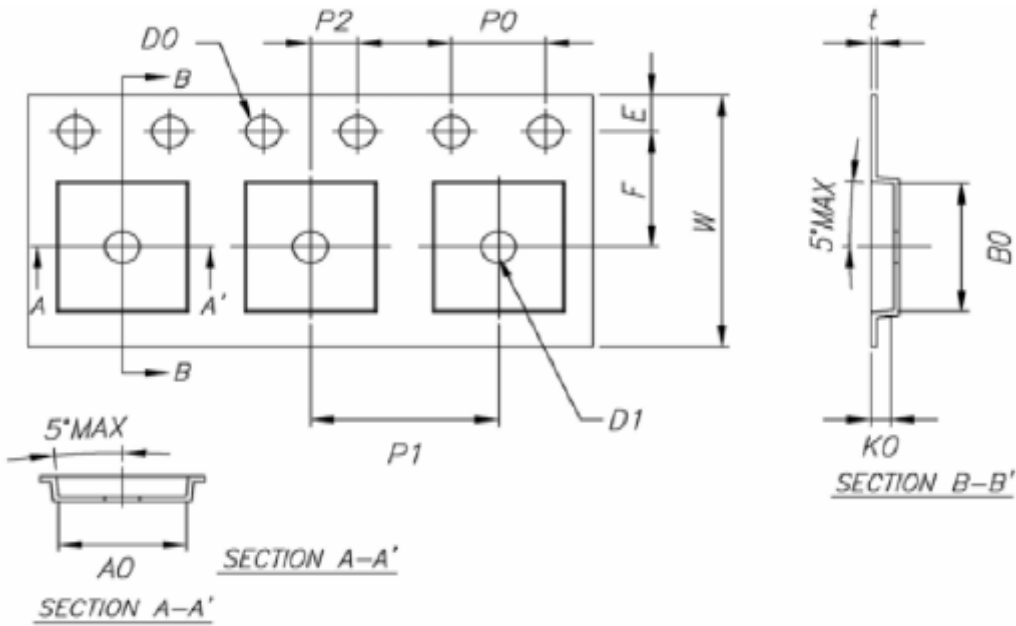
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Label



Carrier Taping



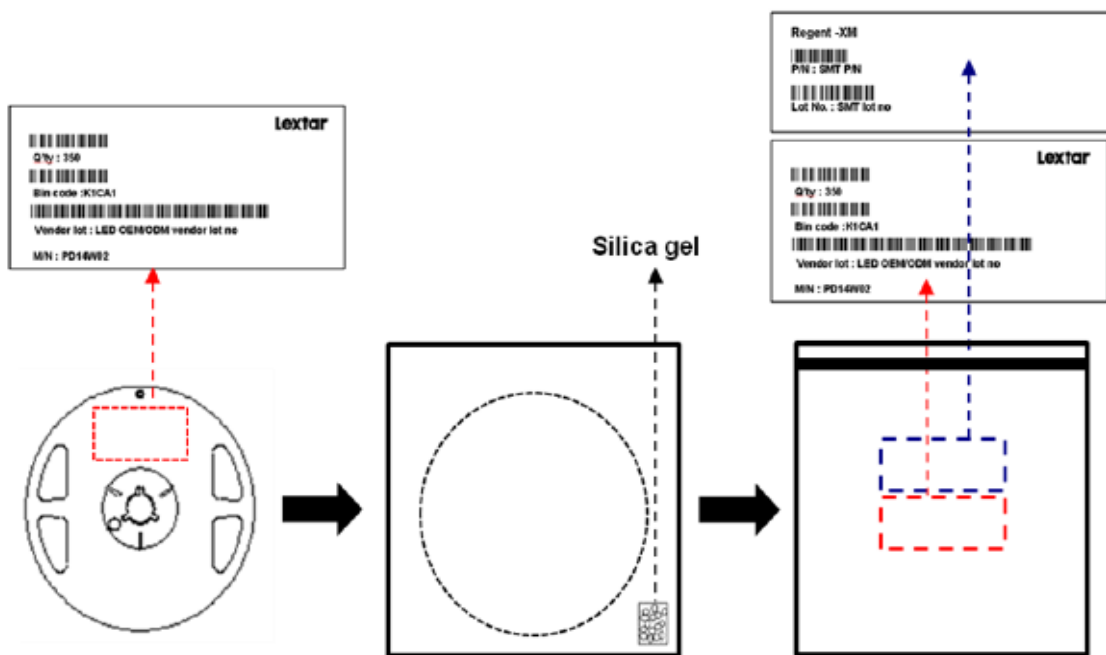


PS : unit : mm

Notice:

1. 10 Sprocket hole pitch cumulative tolerance is $\pm 0.20\text{mm}$.
2. Carrier camber shall be not more than 1mm per 100mm through a length of 250mm.
3. Ao & Bo measured on a place in the middle of the corner radii.
4. Ko measured from a place on the inside bottom of the pocket to top surface of carrier.
5. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
6. Surface resistivity $10^4 \sim 10^8 \text{ ohm/sq}$.

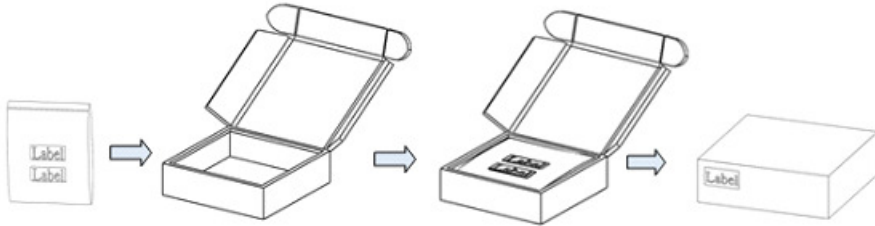
Shield Bag Taping



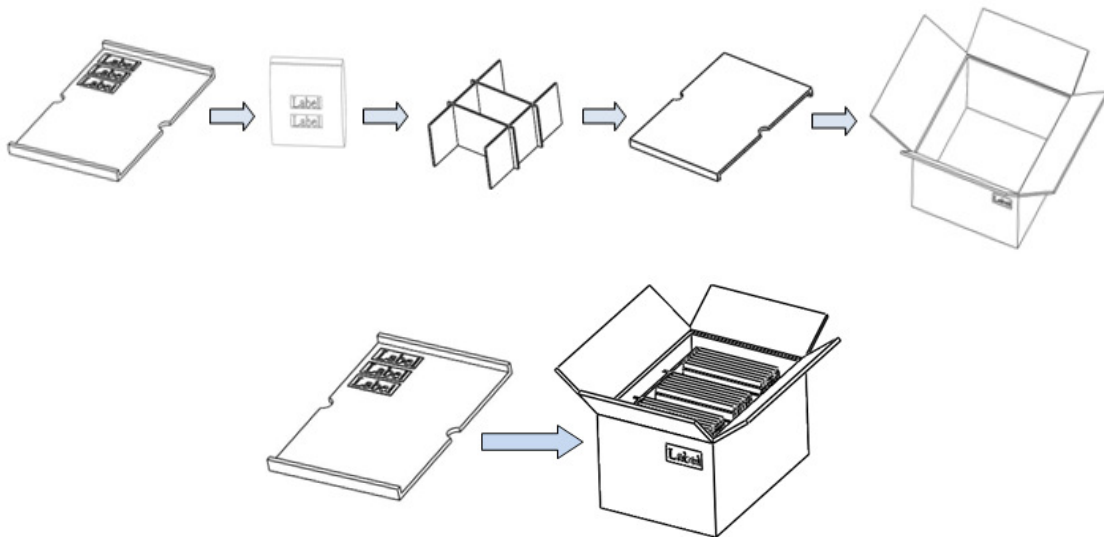
■ **Packing Box**

Type	Large Box		Medium Box		Small Box	
Dimension	541X511X276mm		385X303X260mm		283X235x70mm	
Maximum Reels	7"X12mm Reel	64/R	7"X12mm Reel	21/R	7"X12mm Reel	4/R
Minimum Reels	7"X12mm Reel	32/R	7"X12mm Reel	9/R	7"X12mm Reel	1/R

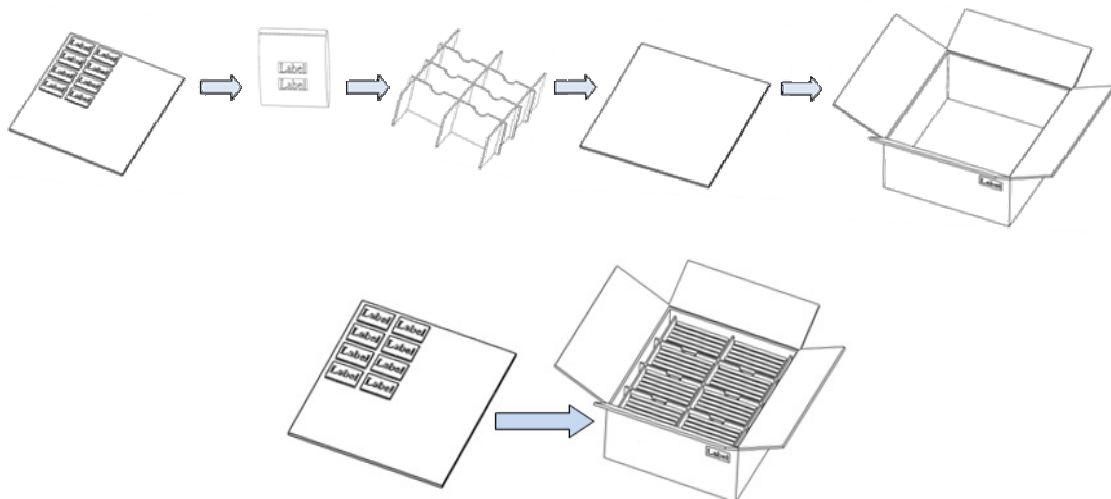
■ **Small Box**



■ **Medium Box**



■ **Large Box**



Precautions

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■ Safety Precautions

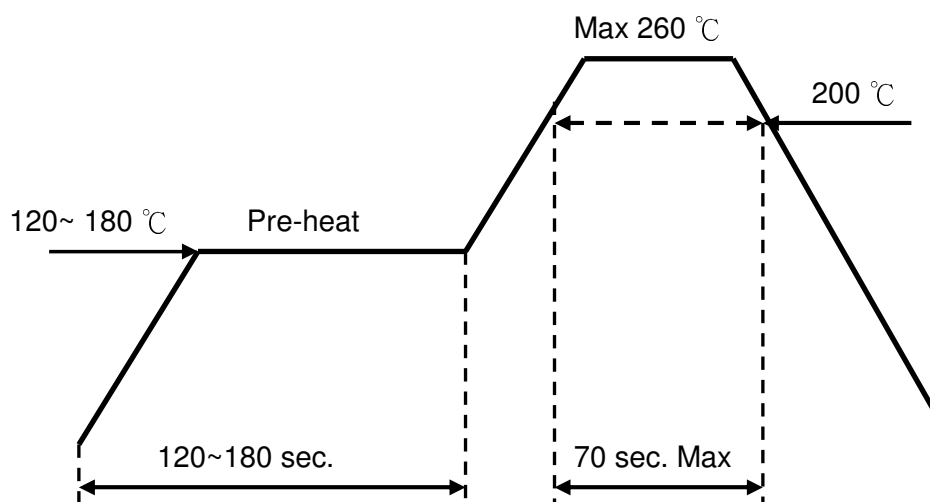
- The LED light output is too strong for human eyes without shield. Prevent eye contact directly more than seconds.
- Ensure operating under maximum rating.

■ Storage

- Before opening the package, the LEDs should storage under 30°C, 60% RH.
- After opening the package bag, the LEDs should be keep under 30°C, 60% RH. Recommend to use within 168 hrs. If unused LEDs remain, suggest to store into moisture proof bag or original package bag with moisture absorbent material such as silica gel. Reseal well is necessary.
- If the product exceeded the storage period or the moisture absorbent material faded away, baking treatment should be done by following conditions.
Bake condition: 60°C, 12hours (One time only).

■ Soldering Notice and Conditions

- When soldering LEDs,
- Do not solder/reflow the same LED over two times.
- Recommend soldering conditions:
Hand soldering: 350 °C max, 3 sec. max.
Reflow soldering: Pre-heat 150 °C max, 180 sec. max.
Peak 260 °C max, 10 sec. max.
- Reflow temperature profile as below: (lead-free solder)



- When soldering, don't put stress on the LEDs
- After LEDs have been soldered, strongly recommend not to repair to keep the LEDs performance.

■ Static Electricity

- LED package is extremely sensitive to static electricity. It's recommended that anti-electrostatic glove and wrist band is necessary when handling the LEDs. All devices are also be grounded properly as well.
- Protection devices design should be considered in the LED driving circuit.

■ Cleaning

- If washing is required, recommend to use alcohol as a solvent.
- Recommend to avoid cleaning the LEDs by ultrasonic. If necessary, pre-test the LED is necessary to confirm whether any damage occur after the process.

Revision History

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Date	Contents	Writer	Approved
2015.11.25	New version	Kenis Hung	Berris Huang

Smart Lighting *Amazing Life*

Lextar Electronics Corp. is the leading LED (Light Emitting Diode) maker integrating upper stream epitaxial, middle stream chip, and downstream package, SMT and LED lighting applications. Founded in May, 2008, Lextar is a subsidiary of AU Optronics, the leading TFT-LCD and solar PV manufacturer. Lextar's product applications include lighting and LCD backlight. Lextar's manufacturing sites include Hsinchu and Chunan in Taiwan, and Suzhou in China. The company turnover in 2010 is 266 million USD.

单击下面可查看定价，库存，交付和生命周期等信息

[>>Lextar\(隆达\)](#)